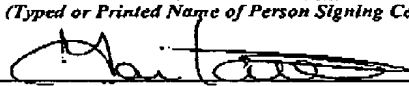


AUG 17 2005

<b>CERTIFICATE OF TRANSMISSION BY FACSIMILE (37 CFR 1.8)</b>			Docket No. <b>YOM-0051</b>
Applicant(s): <b>Bum-Gee BAEK, et al.</b>			
Application No. <b>10/653,556</b>	Filing Date <b>9-2-2003</b>	Examiner <b>Hu, Shouxiang</b>	Group Art Unit <b>2811</b>
Invention: <b>CONTACT STRUCTURE OF SEMICONDUCTOR DEVICE, MANUFACTURING METHOD THEREOF, THIN FILM TRANSISTOR ARRAY PANEL INCLUDING CONTACT STRUCTURE, AND MANUFACTURING METHOD THEREOF</b>			
<p><b>Request for Continued Examination (RCE) Transmittal (1 page), Petition for Extension of Time (1 page) and Authorization to debit and/or credit Deposit Acct. No. 06-1130</b></p> <p>I hereby certify that this _____ (Identify type of correspondence)</p> <p>is being facsimile transmitted to the United States Patent and Trademark Office (Fax. No. <u>571-273-8300</u>)</p> <p>on <u>August 17, 2005</u> (Date)</p> <p><b>Tammie Lanthier</b> (Typed or Printed Name of Person Signing Certificate)</p> <p> (Signature)</p> <p><b>Note: Each paper must have its own certificate of mailing.</b></p>			